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10/395382

1. Kohji SHINOMIYA
- 2.
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3-25-03

March 3, 2003

☐ Mark if Additional Names of Conveying Parties Attached

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Name			
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Address	Chiyoda-ku		
Address	<u>Tokyo</u>		<u>Japan</u>
	City		State/Country

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Attorney Docket No. 402561/SAKAI

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PATENT
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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is acknowledged, the undersigned,

Kohji SHINOMIYA

of c/o Mitsubishi Denki Kabushiki Kaisha

2-3, Marunouchi 2-chome, Chiyoda-ku, TOKYO 100-8310 JAPAN
sells, assigns, and transfers to

Mitsubishi Denki Kabushiki Kaisha

of 2-3, Marunouchi 2-chome, Chiyoda-ku, TOKYO 100-8310 JAPAN

(the Assignee), its successors and assigns, the entire right, title, and interest in and to:

(i) the application for United States Letters Patent entitled:

INTEGRATED CIRCUIT CHIP MODULE

which was executed by the undersigned on March 3,
2003 or was filed on _____ and accorded Serial
No. _____ (the Application);

(ii) any and all inventions and improvements that are described
in the Application;

(iii) any and all United States Letters Patents that may be
granted on the Application (the Patent);

(iv) any and all divisions, continuations, reexaminations,
reissues, or extensions of the Application or the Patent;
and

(v) all benefits under the International Convention for the
Protection of Industrial Property.

I authorize the Assignee and its agents to insert in this
instrument the filing date and serial number of the Application.

I authorize and request the Commissioner of Patents to issue
any and all Letters Patent, when granted, to the Assignee.

Further, it is agreed that, when requested, without charge to, but at the expense of, the Assignee, the undersigned will execute all divisional, continuing, or reissue patent applications; execute all additional assignments and other writings, including reissue and reexamination papers; and provide all reasonable assistance requested by the Assignee to secure and maintain appropriate patent protection for any invention described in the Application.

INVENTOR

Date

Kohji Shinomiya
Kohji SHINOMIYA

March 3, 2003

